

# **BSR18B** PNP General Purpose Amplifier

This device is designed as a general purpose amplifier and switch.

Sourced from Process 23.



# Absolute Maximum Ratings \* T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	40	V
V <sub>CEO</sub>	Collector-Emitter Voltage	40	V
V <sub>EBO</sub>	Emitter-Base Voltage	5.0	V
l <sub>C</sub>	Collector Current (DC)	200	mA
T <sub>J,</sub> T <sub>STG</sub>	Junction Temperature, Storage Temperature	-55 ~ +150	°C

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Thermal Characteristics $T_a = 25^{\circ}C$ unless otherwise noted

Symbol	Characteristic	Max	Units
PD	Total Device Dissipation	230	mW
	Derate above 25℃	1.84	mW/°C
R ⊖ JA	Thermal Resistance, Junction to Ambient	550	°C/W

\*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06".

PNP General Purpose Amplifier

June 2007

BSR18B
PNP
General
Purpose
Amplifier

Symbol	Parameter	Test Condition	MIN	MAX	Units
Off Charac	cteristics				
V(BR)CEO	Collector-Emitter Breakdown Voltage	Ic = 1.0 mA, I <sub>B</sub> = 0	40		V
V(BR)CBO	Collector-Base Breakdown Voltage	Ic = 10 μA, Iε = 0	40		V
V(BR)EBO	Emitter-Base Breakdown Voltage	Iε = 10 μA, Ic = 0	5.0		V
Ісво	Collector-Cutoff Current	V <sub>CB</sub> = 30 V		50	nA
Ево	Emitter-Cutoff Current	Vce = 30 V, Veb = 3.0 V		50	nA
On Charac	teristics	·	·		
hfe	DC Current Gain	$\label{eq:constraint} \begin{array}{l} Ic = 0.1 \text{ mA}, \text{ Vce} = 1.0 \text{ V} \\ Ic = 1.0 \text{ mA}, \text{ Vce} = 1.0 \text{ V} \\ Ic = 10 \text{ mA}, \text{ Vce} = 1.0 \text{ V} \\ Ic = 50 \text{ mA}, \text{ Vce} = 1.0 \text{ V} \\ Ic = 100 \text{ mA}, \text{ Vce} = 1.0 \text{ V} \end{array}$	60 80 110 60 30	220	
Vce(sat)	Collector-Emitter Saturation Voltage *	$I_{C} = 10 \text{ mA}, I_{B} = 1.0 \text{ mA}$ $I_{C} = 50 \text{ mA}, I_{B} = 5.0 \text{ mA}$		0.25 0.4	V V
V <sub>BE</sub> (sat)	Emitter-Base Breakdown Voltage *	Ic = 10 mA, IB = 1.0 mA Ic = 50 mA, IB = 5.0 mA	0.65	0.85 0.95	V V
Small Sigr	nal Characteristics				
Ccb	Collector-Base Capacitance	Vcb = 5.0 V, Ie = 0, f = 100 kHz		4.5	pF
Ceb	Emitter-Base Capacitance	V <sub>EB</sub> = 0.5 V, Ic = 0, f = 100 kHz	T	10	pF

### Switching Characteristics

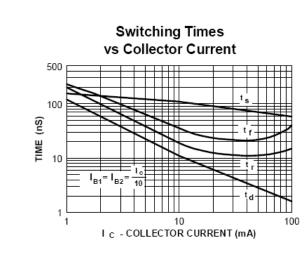
td	Delay Time	Ic = 10 mA, IB1 = 1.0 mA,Vcc= 3.0 V	35	ns
tr	Rise Time		35	pF
ts	Storage Time	Ic = 10 mA, IBon = IBoff = 1.0 mA	225	ns
tr	Fall Time	Vcc= 3.0 V	75	ns

\* Pulse Test: Pulse Width ${\leq}300\mu s,$  Duty Cycle ${\leq}2\%$ 

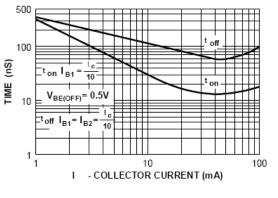
NOTE: All voltages (V) and currents (A) are negative polarity for PNP transistors.

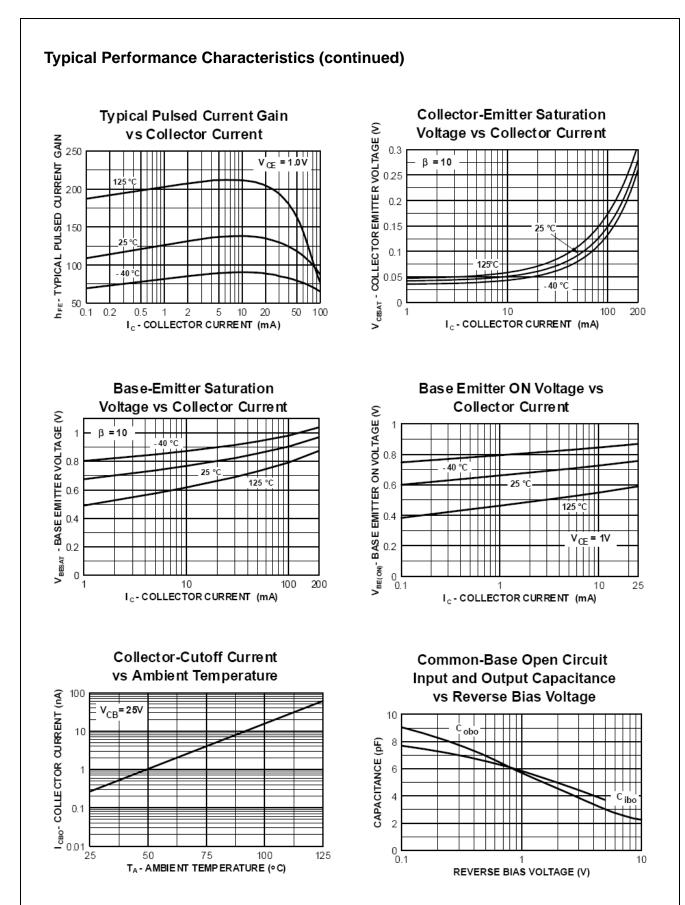
Electrical Characteristics \* T<sub>a</sub> = 25°C unless otherwise noted





# Turn On and Turn Off Times vs Collector Current







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